# Surface Mount Limiter PIN Diode



# MLP7131-2012

Rev. V2

#### Features

- Low Junction Capacitance for Low Insertion Loss and High Isolation:  $C_{\rm T}6$  <0.35 pF
- Low Series Resistance for High Isolation:  $R_s < 1.5 \Omega$
- Nominal I Layer Width: W = 2.6 μm
- Compact Surface Mount Plastic Package
- RoHS\* Compliant

#### **Applications**

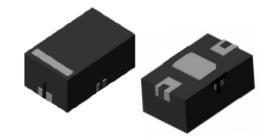
• Aerospace & Defense

#### Description

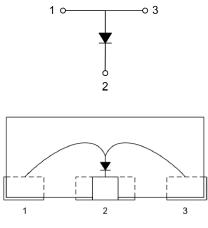
The MLP7131-2012 limiter PIN diode is a low series resistance, low capacitance limiter PIN diode packaged in a surface mount, low-parasitic plastic package. It is manufactured using a proprietary diode process for excellent performance and high reliability.

The 2.6  $\mu$ m nominal I layer width of this diode produces a threshold level of 7 dBm nominal, for demanding receiver protection applications. The low series resistance (<1.5  $\Omega$ ), and low total capacitance (<0.35 pF) of MLP7131-2012 produce excellent isolation and insertion loss in shunt, receiver protection applications.

The MLP7131-2012 limiter PIN diode is designed to be used in receiver protection applications.



## Pin Out / Schematic



Side View

# **Ordering Information**

Part Number	Package
MLP7131-2012	500 piece reel
MLP7131-2012-B	100 per bag bulk
MLP7131-2012-W	400 piece waffle pack

\* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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## Electrical Specifications: $T_A = +25^{\circ}C$ (measured on evaluation board)

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Breakdown Voltage (V <sub>B</sub> )	I <sub>R</sub> = 10 μA	V	20	—	35
Forward Voltage (V <sub>F</sub> )	I <sub>F</sub> = 10 mA	V	—	0.9	.95
Total Capacitance <sup>1</sup> (C <sub>T</sub> )	V <sub>R</sub> = 6 V, 1 MHz	pF	—	—	0.35
Series Resistance <sup>2</sup> (R <sub>S</sub> )	I <sub>F</sub> = 1 mA, 1 GHz I <sub>F</sub> = 10 mA, 1 GHz	Ω	_	3.5 1.5	—
Recovery Time (T <sub>R</sub> )	End of the RF input to 1 dB excess insertion loss	ns		10	_
Minority Carrier Lifetime (T <sub>L</sub> )	50% control to 90% output voltage, $I_F$ = 10 mA, $I_R$ = 6 mA, 1 KHz	ns		10	
Thermal Resistance ( $\theta_{JC}$ )	_	°C/W	—	35	_
I layer Thickness (W)	_	μm	—	2.6	_

1. Total capacitance ( $C_T$ ) is the sum of the diode junction capacitance ( $C_J$ ) and the package capacitance ( $C_{PKG}$ ).

2. Series resistance ( $R_s$ ) is measured on the HP 4291 Impedance Analyzer.

## **Absolute Maximum Ratings**

Parameter	Test Conditions	Absolute Maximum
Forward DC Current	_	150 mA
Reverse DC Voltage		180 V
Forward DC Voltage	I <sub>F</sub> = 150 mA	1.3 V
Peak RF Input Power	Pulse Width = 1 µs, Duty Cycle = 1%	90 W
CW Input Power	_	3 W
Junction Temperature	—	+175°C
Operating Temperature	_	-55°C to +150°C
Storage Temperature	—	-65°C to +175°C
Assembly Temperature	t = 10 s	+260°C

### Handling Procedures

Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

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These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 0 devices.

### **Moisture Sensitivity**

These electronic devices are rated MSL 1.

# **Environmental Capabilities**

Capable of meeting the environmental requirements of MIL-STD-750 and MIL-STD-883.

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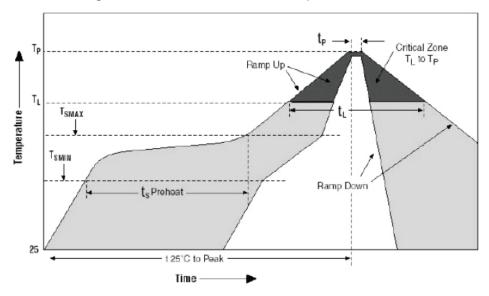
#### Assembly Instructions

Diodes may be placed onto circuit boards with pick and place manufacturing equipment from tape-reel. The devices are attached to the circuit using conventional solder re-flow or wave soldering procedures with RoHS type or Sn 60 / Pb 40 type solders.

Profile Feature	SnPb Solder Assembly	Pb-Free Solder Assembly	
Average Ramp-Up Rate (T <sub>L</sub> to T <sub>P</sub> )	3°C /second maximum	3°C /second maximum	
Preheat: -Temperature Min (T <sub>SMIN</sub> ) -Temperature Max (T <sub>SMAX</sub> ) -Time (min to max)(t <sub>S</sub> )	100°C 150°C 60 - 120 s	150°C 200°C 60 - 180 s	
T <sub>SMAX</sub> to T <sub>L</sub> - Ramp-Up Rate		3°C /s maximum	
Time Maintained Above: -Temperature $(T_L)$ - Time $(t_L)$	183°C 60 - 150 s	217°C 60 - 150 s	
Peak temperature (T <sub>P</sub> )	225 +0/-5°C	260 +0/-5°C	
Time Within 5°C of Actual Peak Temperature (t <sub>P</sub> )	10 – 30 s	20 – 40 s	
Ramp-Down Rate	6°C /s maximum	6°C /s maximum	
Time 25°C to Peak Temperature	6 minutes maximum	num 8 minutes maximum	

#### Table 1. Time-Temperature Profile for Sn60/Pb40 or RoHS Type Solders

#### Figure 1. Solder Re-Flow Time-Temperature Profile



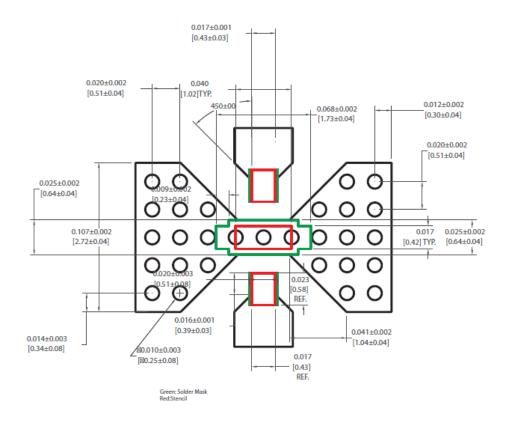
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# Printed Circuit Board Layout (Soldering Footprint)<sup>3,4,5,6,7</sup>



- 3. Unless otherwise specified: Tolerance ±0.10 mm.
- 4. If possible, use copper filled vias underneath pin 3 for better thermals; otherwise, use vias that are plated through, filled and plated over.
- 5. Solder mask should provide a 60 µm clearance between copper pad and soldermask. Rounded package pads should have matching rounded solder mask openings.
- 6. Use circles or squares for thermal land stencil such that there is only 50% to 80% solder paste coverage.
- 7. 20 mils Rogers RO4350B with 1 oz. copper clad and 10 mil diameter plated thru vias on 20 mil centers underneath package.

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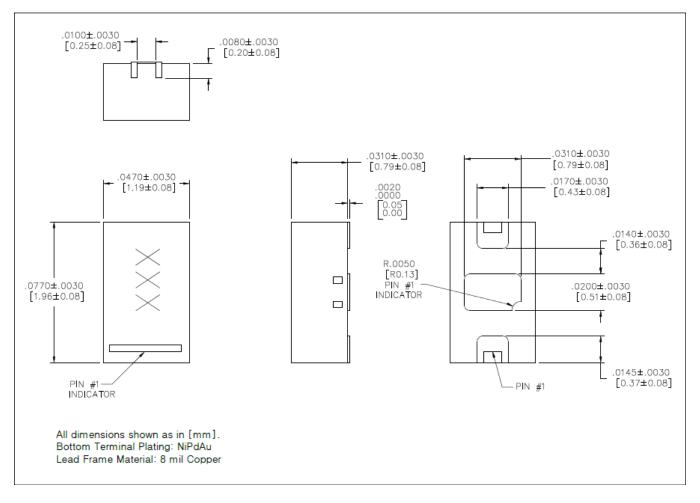
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# Package Outline



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